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Substitute for form 1449A/PTO

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Sheet 1 of 1

Application Number	10/079,270
Filing Date	2/20/02
First Named Inventor	Steven Teig
Group Art Unit	2825
Examiner Name	PAUL DINH
Attorney Docket Number	SPLX.P0127

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¹ Unique citation designation number. ² See attached Kinds of U.S. Patent Documents. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

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Sheet 2 of 2

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Group Art Unit	2825
Examiner Name	PAUL DINH
Attorney Docket Number	SPLX.P0127

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First Named Inventor	Steven Teig
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Examiner Name	PAUL DINH
Attorney Docket Number	SPLX.P0127

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Signature Considered 3/79/5	- Wai 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		3/14	1/0 0

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